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Silicon PNP Triple Diffused

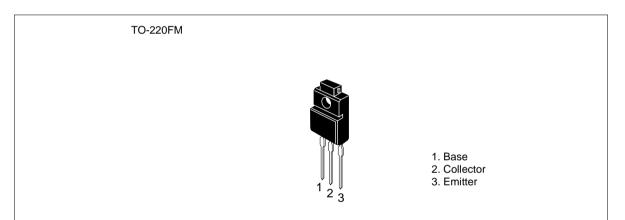


ADE-208-872 (Z) 1st. Edition September 2000

Application

Low frequency power amplifier

Outline



Absolute Maximum Ratings (Ta = 25°C)

n Symbol		Unit	
V _{CBO}	-70	V	
V _{CEO}	-60	V	
V _{EBO}	-5	V	
Ι _c	-4	А	
I _{C(peak)}	-8	А	
Pc	2	W	
Pc*1	25		
Tj	150	°C	
Tstg	-55 to +150	°C	
		$\begin{array}{c c} V_{CBO} & -70 \\ \hline V_{CEO} & -60 \\ \hline V_{EBO} & -5 \\ \hline I_{C} & -4 \\ \hline I_{C(peak)} & -8 \\ \hline P_{C} & 2 \\ \hline P_{C}^{*1} & 25 \\ \hline Tj & 150 \\ \end{array}$	

Note: 1. Value at $T_c = 25^{\circ}C$.

Electrical Characteristics (Ta = 25°C)

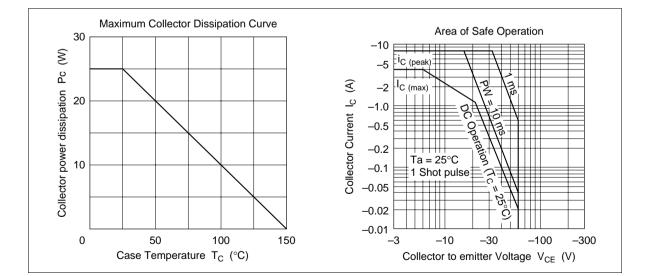
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{\rm (BR)CBO}$	-70	_	_	V	$I_{c} = -10 \ \mu A, \ I_{E} = 0$
Collector to emitter breakdown voltage	$V_{\rm (BR)CEO}$	-60	_	_	V	$I_c = -50 \text{ mA}, \text{ R}_{BE} = \infty$
Emitter to base breakdown voltage	$V_{(\text{BR})\text{EBO}}$	-5	_	_	V	$I_{\rm E} = -10 \ \mu A, \ I_{\rm C} = 0$
Collector cutoff current	I _{CBO}		_	-10	μΑ	$V_{\rm CB} = -50 \text{ V}, I_{\rm E} = 0$
	I _{CEO}		_	-10		$V_{ce} = -50$ V, $R_{be} = \infty$
DC current transfer ratio	$h_{\rm FE1}^{*2}$	60		200		$V_{ce} = -4 V, I_c = -1 A^{*1}$
	h_{FE2}	35				$V_{ce} = -4 \text{ V}, \text{ I}_{c} = -0.1 \text{ A}^{*1}$
Base to emitter voltage	V_{BE}	_		-1.0	V	$V_{ce} = -4 V, I_c = -1 A^{*1}$
Collector to emitter saturation voltage	$V_{\text{CE(sat)}}$	—	_	-1.0	V	$I_{\rm c} = -2.0$ A, $I_{\rm B} = -0.2$ A ^{*1}
Base to emitter saturation voltage	$V_{\text{BE(sat)}}$	_	_	-1.2	V	$I_{\rm C} = -2.0 \text{ A}, I_{\rm B} = -0.2 \text{ A}^{*1}$

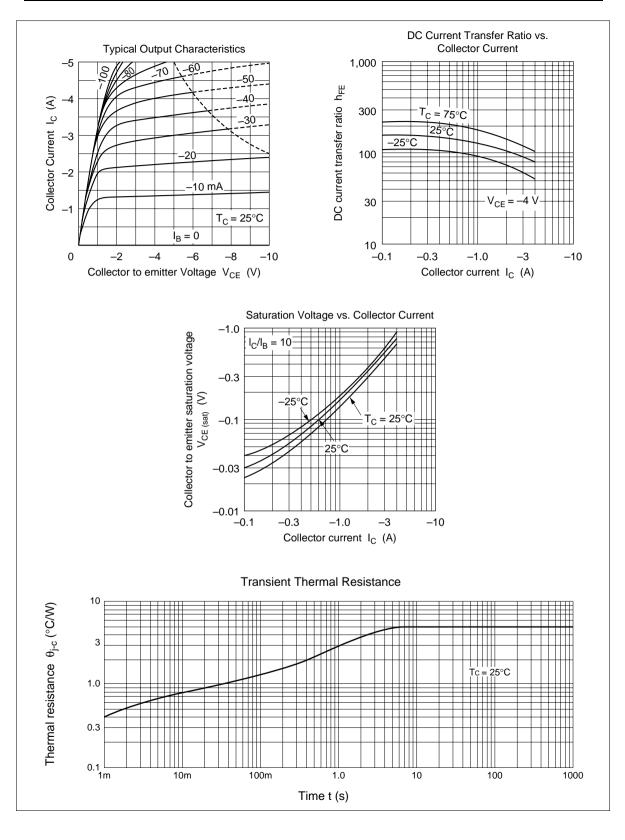
Notes: 1. Pulse test.

2. The 2SB1392 is grouped by $h_{\mbox{\tiny FE1}}$ as follows.

B C

60 to 120 100 to 200





RENESAS

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